

TWEPP 2019 Topical Workshop on Electronics for Particle Physics

Wednesday, 4 September 2019

Packaging and Interconnects - Aula magna (11:30 - 12:20)

-Conveners: Francois Vasey

time	[id] title	presenter
11:30	[44] Prototyping of Hybrid Circuits for the CMS Phase Two Outer Tracker Upgrade at the HL-LHC	BLANCHOT, Georges RASEVIC, Nikola
11:55	[131] Power hybrids for silicon modules with macro-pixel and strip sensors for the CMS Phase-2 tracker upgrade	KLEIN, Katja